

Automatic Generation of Geometrically Parameterized Reduced Order Models for Integrated Spiral RF-Inductors

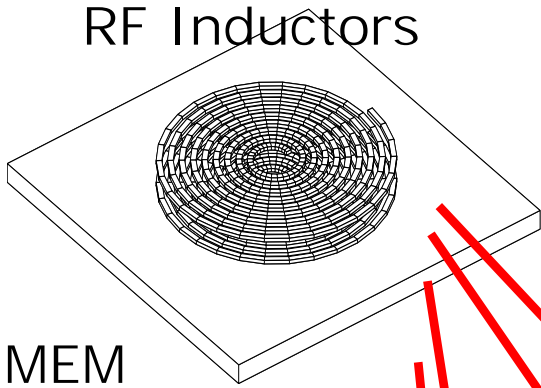
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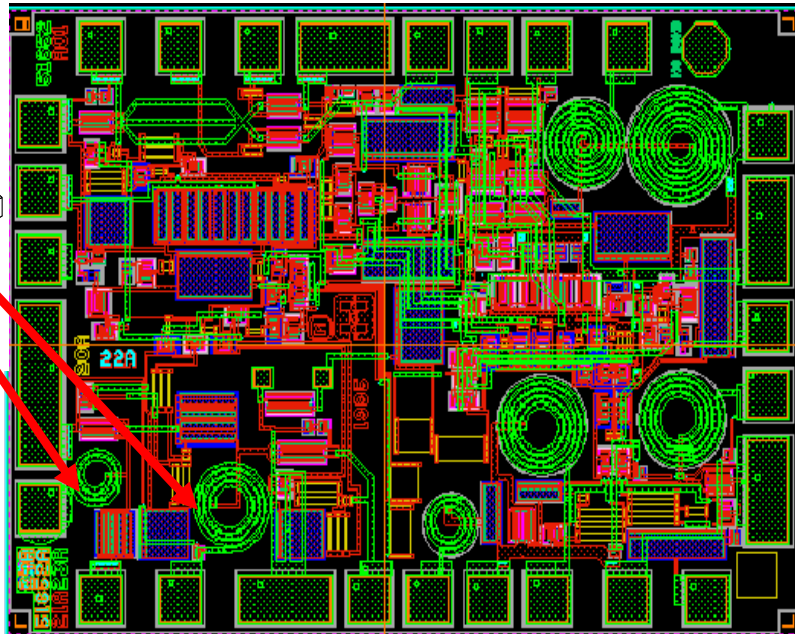
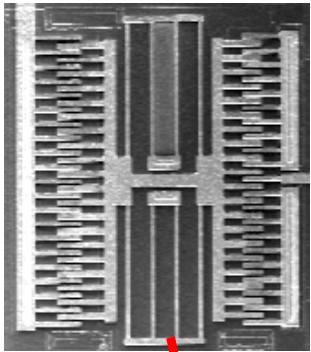
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managed by the Sensors Directorate of the Air Force
Laboratory, USAF, Wright-Patterson AFB.**

Systems on Chip or Package: heterogeneous components analog RF + MEM + mixed signal + digital

RF Inductors

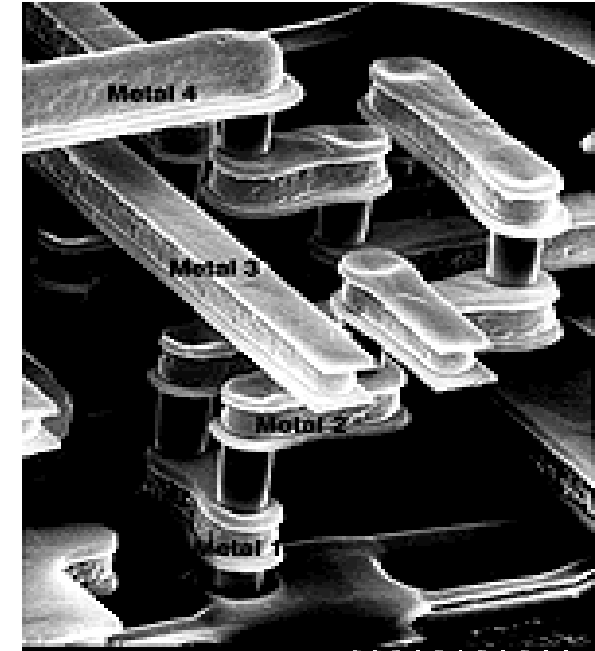


MEM resonators



Courtesy of Harris semiconductor

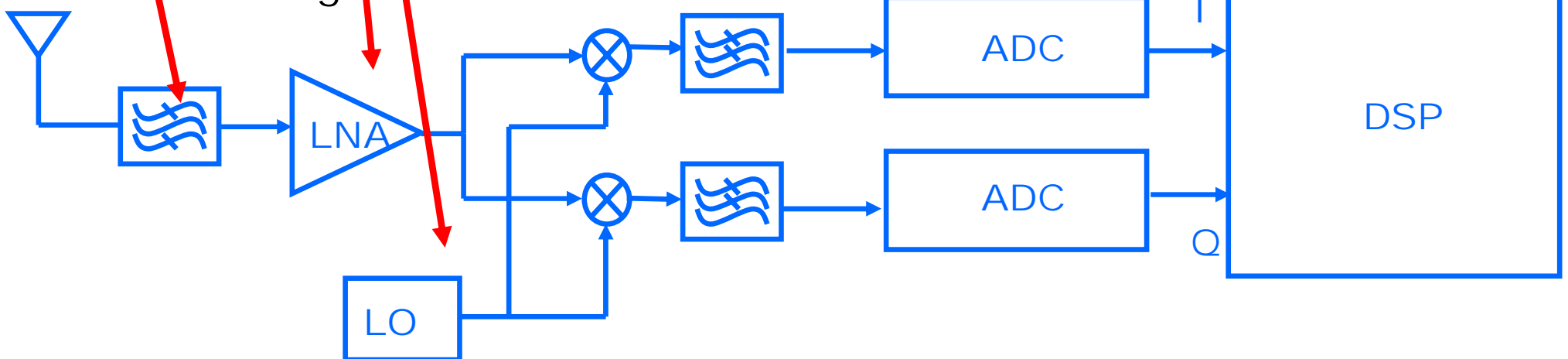
Interconnect and Substrate



Analog RF

Mixed Signal

Digital



Verification of the overall system performance is a challenge

RF Inductors

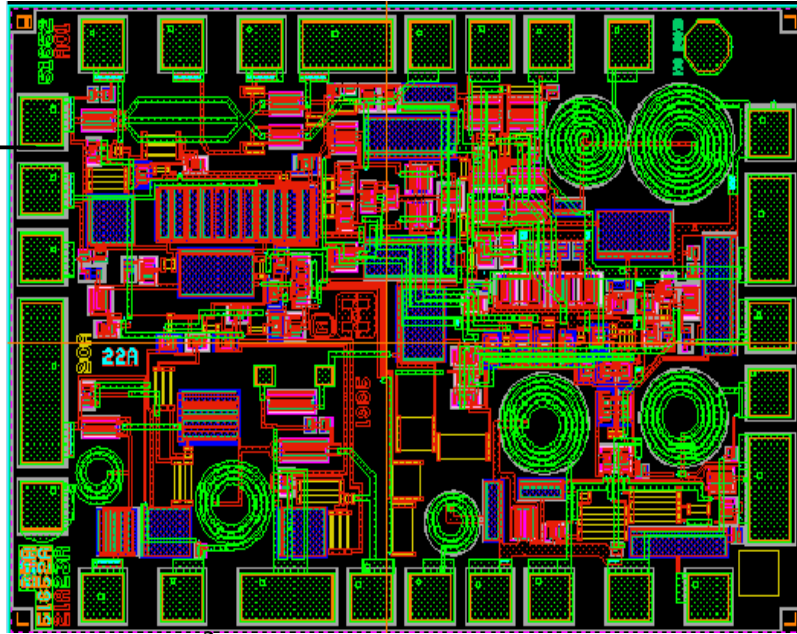
$$\nabla \times E = -\mu \frac{dH}{dt}$$

$$\nabla \times H = \varepsilon \frac{dE}{dt}$$

MEM resonators

$$EI \frac{\partial^4 u}{\partial x^4} - S \frac{\partial^2 u}{\partial x^2} = F_{elec} + \int_0^w (p - p_a) dy - \rho \frac{\partial^2 u}{\partial t^2}$$

$$\nabla \cdot ((1 + 6K)u^3 p \nabla p) = 12\mu \frac{\partial(pu)}{\partial t}$$



Courtesy of Harris semiconductor

Interconnect and Substrate

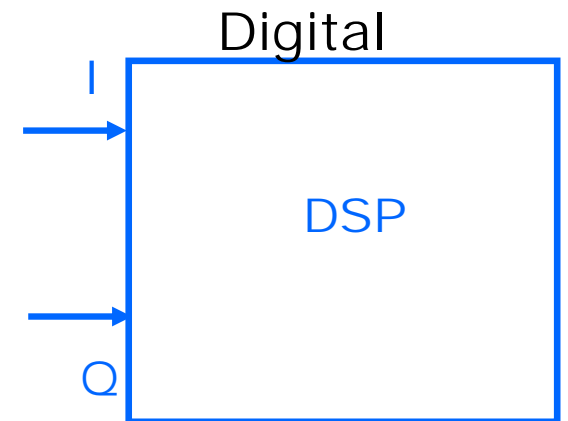
$$\nabla \times E = -\mu \frac{dH}{dt}$$

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Analog RF

Mixed Signal

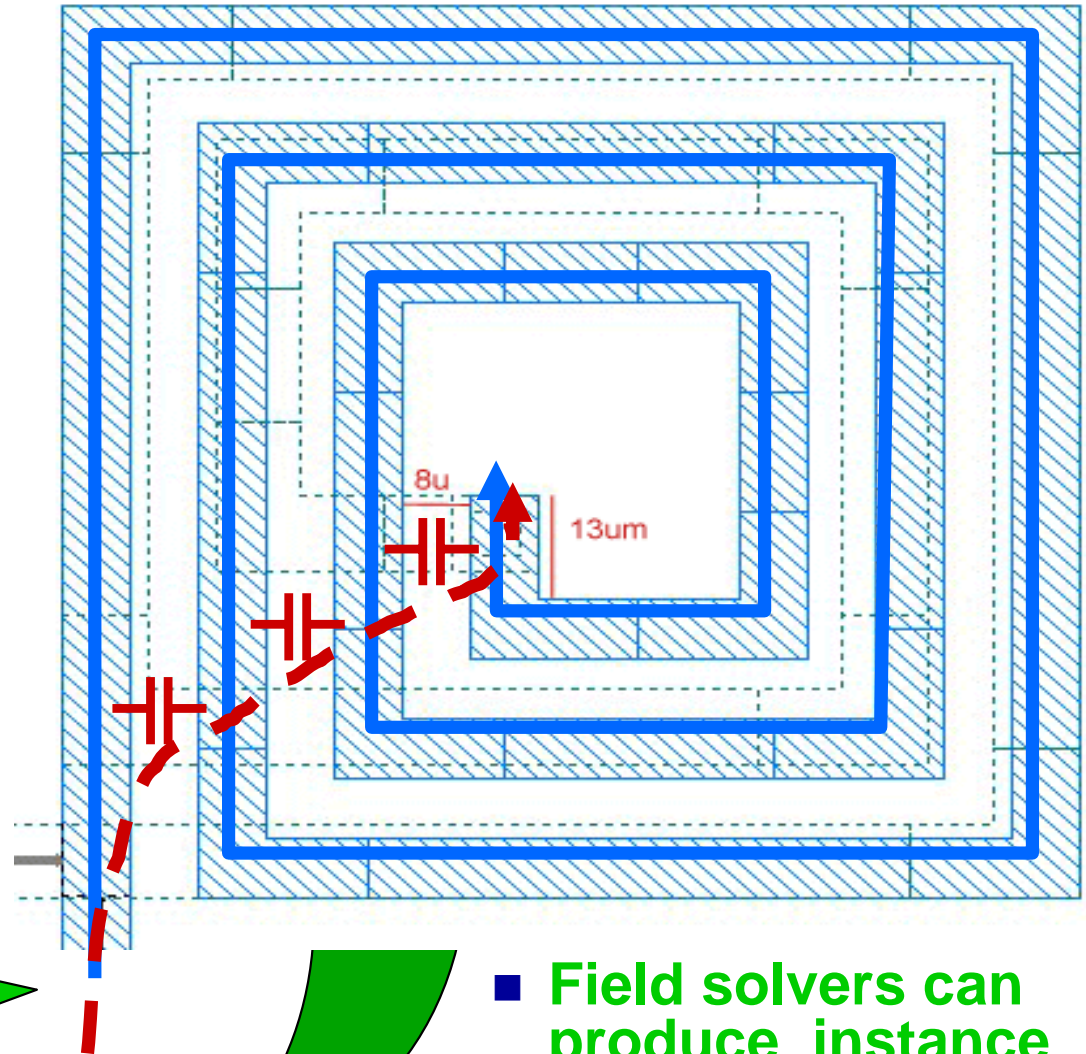
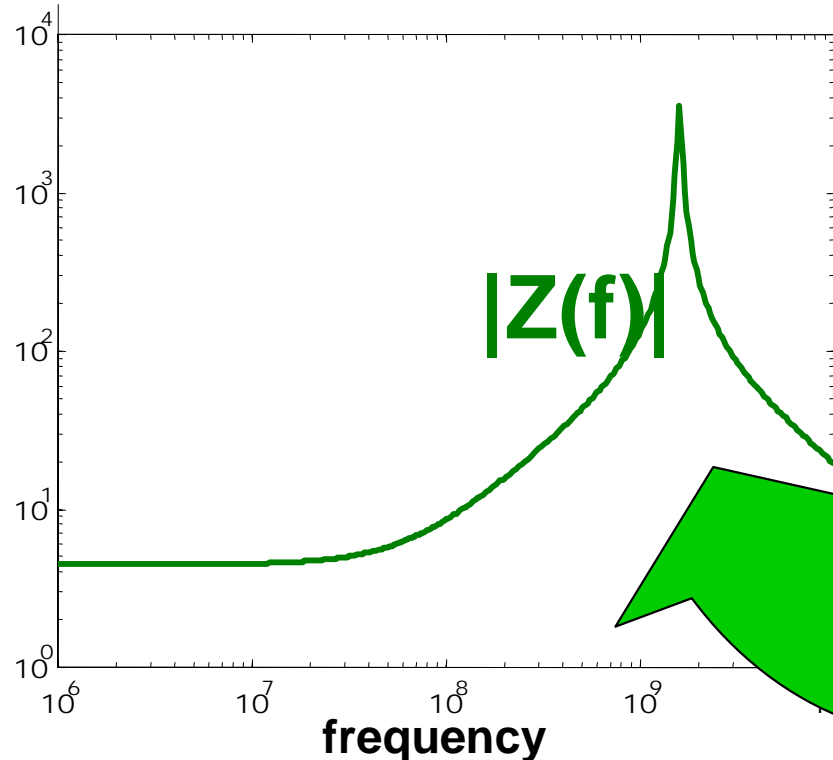
$$C(v) \frac{dv}{dt} = -G(v) + Bv_{in}$$



Motivation.

Example: RF micro-inductor

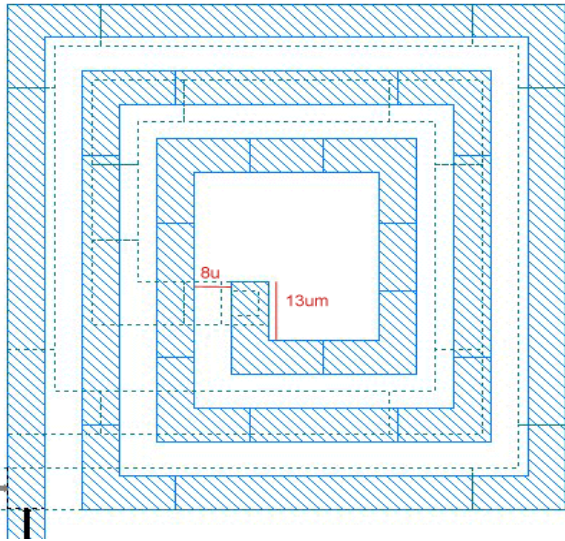
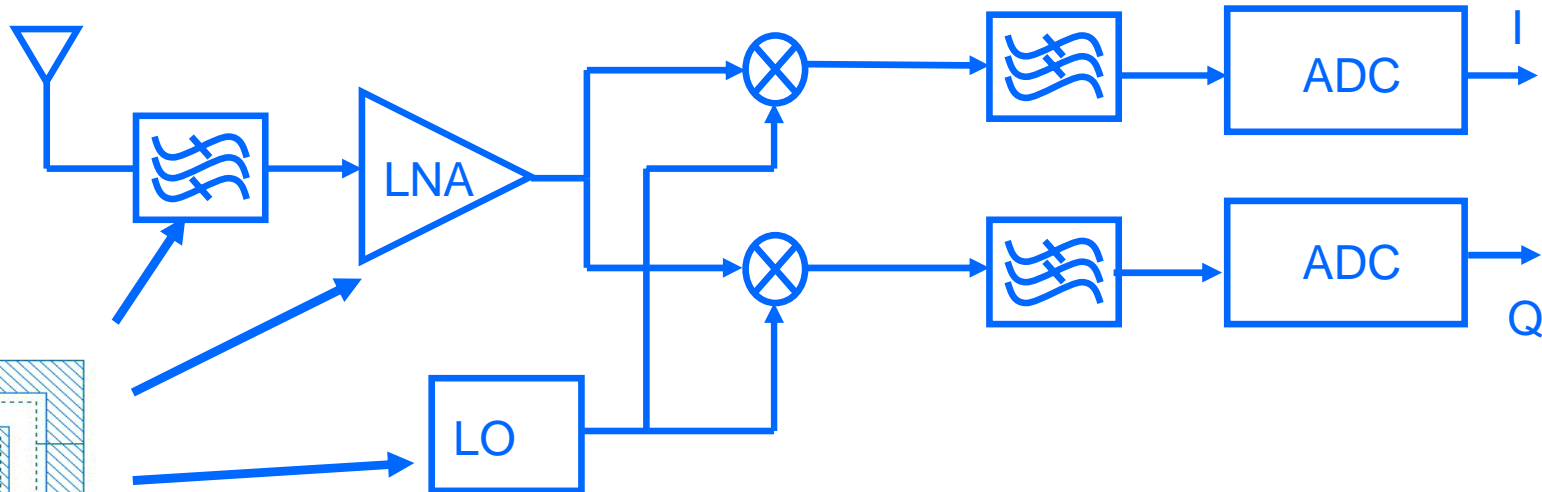
- How are the **substrate eddy currents** affecting the quality factor of the inductor?
- How are the **displacement currents** affecting the resonance of the inductor?
- Need to capture **all 2nd order effects**



- Field solvers can produce instance impedance vs. frequency curves.

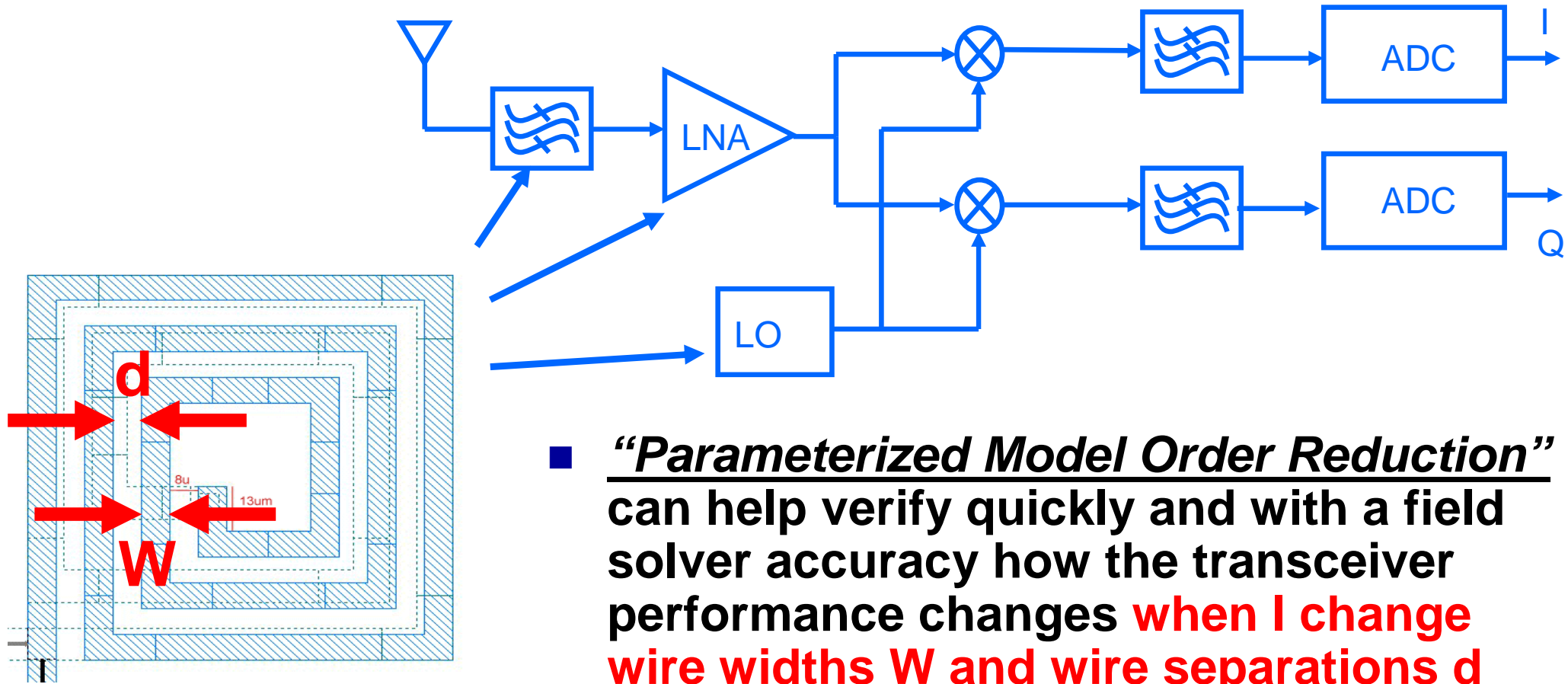
Motivation

Example: RF micro-inductor



- **“Model Order Reduction”** can help **verify how the inductor performance** (Q, resonance position, etc) **affect the transceiver performance** (distortion, interference rejection etc.)
- **Modeling Requirements:**
 - **as accurate as a field solver**
 - **automatic and robust**
 - **model compatible with circuit simulators**

Motivation. An attempt to filling Jaijeet's "Gap" between bottom-up verification and system design



- **“Parameterized Model Order Reduction”** can help verify quickly and with a field solver accuracy how the transceiver performance changes **when I change wire widths W and wire separations d**
- Hence it can be used within an optimization loop for automatic system design

Previous work

- Parameterized reduced-order models focusing on **statistical data mining performance evaluation**
 - for interconnect [Liu DAC99, Heydari ICCAD01]
 - and for analog circuit blocks [Rutenbar DAC02]

Quoting Rutenbar's plot

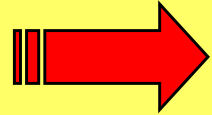


- parameterized **moment-matching** model reduction
 - Moment sensitivity based wire sizing for clock skew minimization [Pullela TCAD97]
 - with two parameters [Weile Applied Math. Letters 1999]
 - and with p-parameters applied to RC models of interconnect [Daniel ISPD02].
 - reducing a discretized linear parameterized PDE [Prud'homme Journal Fluids Eng. 2002].
 - ALL FOR LINEARLY PARAMETERIZED SYSTEMS

Outline

- Motivations

- Background



- A Volume Integral Equation (VIE) formulation

- From VIE to dynamical linear systems

- Linearly Parameterized Projection-based Model Reduction

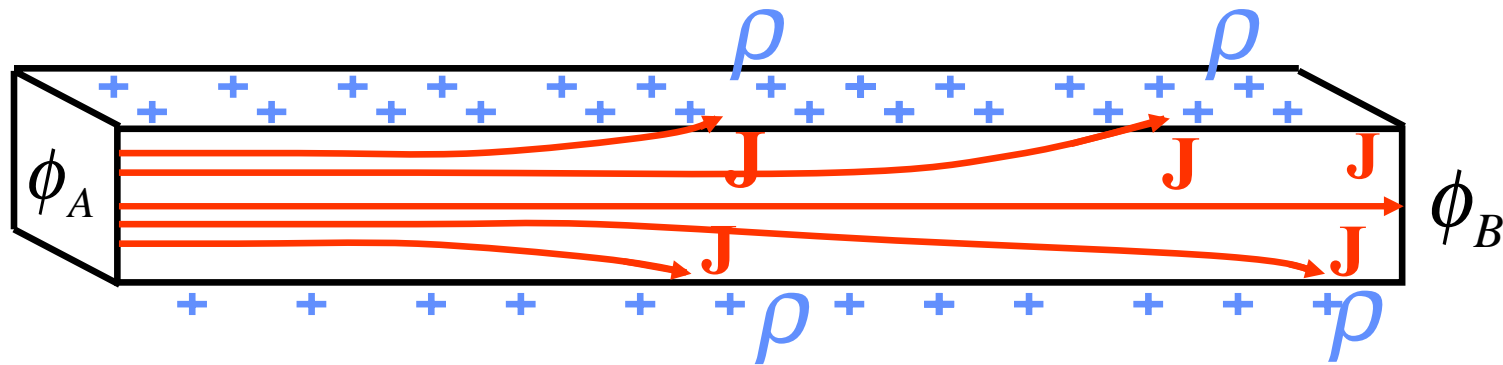
- An interpolation approach for non-linearly parameterized model order reduction

- RF-inductor Results

- Future Work and Conclusions

Background

Volume Integral Equation Method



$$\frac{\mathbf{J}(\mathbf{r})}{\sigma} + j\omega \frac{\mu}{4\pi} \int_V \mathbf{J}(\mathbf{r}') \frac{1}{|\mathbf{r} - \mathbf{r}'|} d\mathbf{r}' = -\nabla \phi$$

resistive effect **magnetic coupling**

$$\frac{1}{4\pi\epsilon} \int_S \rho(\mathbf{r}_s') \frac{1}{|\mathbf{r}_s - \mathbf{r}_s'|} d\mathbf{r}_s' = \phi(\mathbf{r}_s)$$

charge-voltage relation

$$\nabla \cdot \mathbf{J}(\mathbf{r}) = 0$$

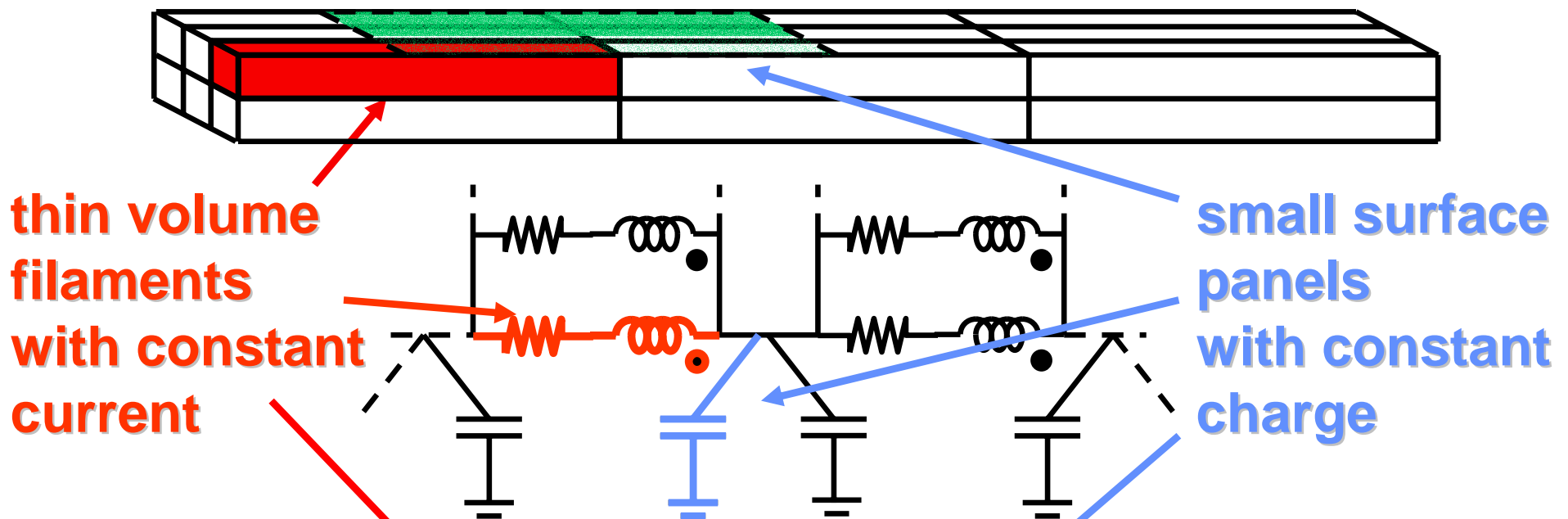
$$\hat{\mathbf{n}} \cdot \mathbf{J}(\mathbf{r}) = j\omega\rho(\mathbf{r}_s)$$

current and charge conservation

Background [PEEC Ruehli74]

Discretization Basis Functions

- Standard numerical procedure: discretize volume currents and surface charges.



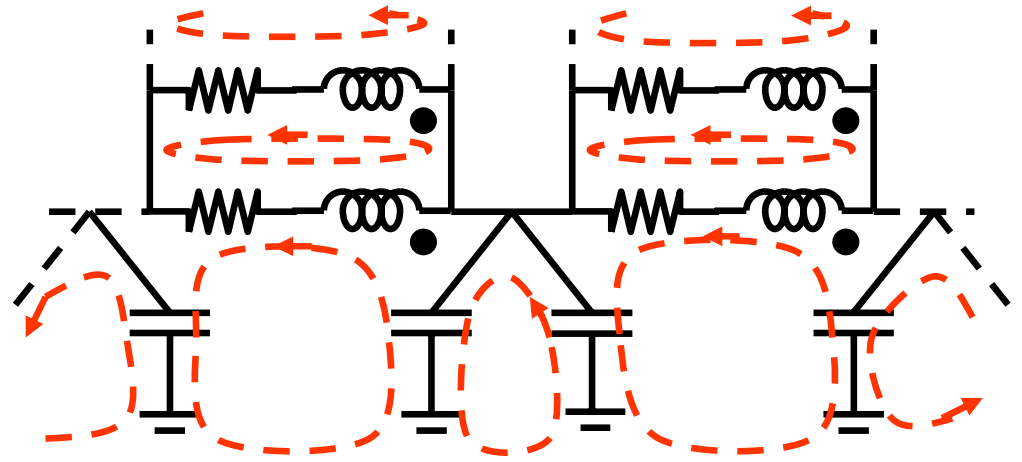
- Discretization gives system of equations:

$$\begin{bmatrix} R_c + j\omega L_c & 0 \\ 0 & P_c \end{bmatrix} \begin{bmatrix} I_c \\ q_c \end{bmatrix} = \begin{bmatrix} V_c \\ \phi_c \end{bmatrix}$$

Background: Mesh Analysis

[Kamon et al. Trans Packaging98]

Imposing current conservation with **mesh analysis (KVL)**

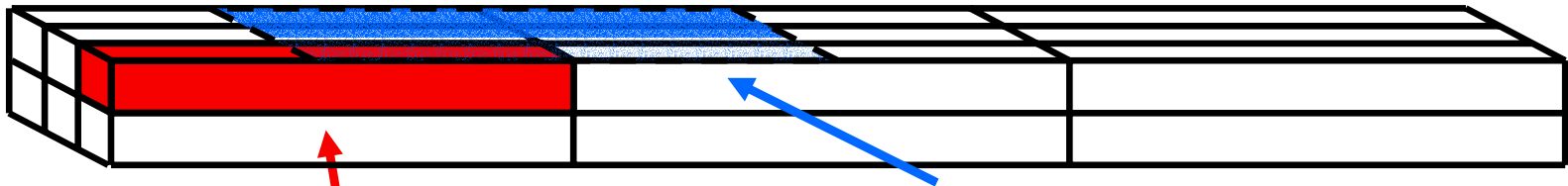


$$M \begin{bmatrix} R_c + j\omega L_c & 0 \\ 0 & 0 \end{bmatrix} M^T I_m = V_{ms}$$

Background (Fastpep ICCAD97)

Volume Integral Equation Method (cont.)

- Piece-wise constant discretization basis functions: volume filaments for currents, surface panel for charges.



thin volume filaments
with constant current

small surface panels
with constant charge

- Discretization produces a huge state space dynamical linear system:

$$\underset{\text{L}}{S} \begin{bmatrix} M_f L_f M_f^T & 0 \\ 0 & P^{-1} \end{bmatrix} x = - \underset{\text{R}}{\begin{bmatrix} M_f R_f M_f^T & M_p \\ -M_p^T & 0 \end{bmatrix}} x + \begin{bmatrix} V_m \\ 0 \end{bmatrix} u$$

Background

Non-parameterized Model order reduction

- Given a large linear system model:

$$s \quad E \quad \begin{bmatrix} x \\ x \\ b \end{bmatrix} u$$
$$y = c^T x$$

500,000 x 500,000

- Construct a linear system model with:
 - smaller complexity
 - same fidelity
 - small reduction cost

$$s \quad \hat{E} \quad \begin{bmatrix} \hat{x} \\ \hat{x} \\ \hat{b} \end{bmatrix} u$$
$$y = \hat{c}^T \hat{x}$$

20 x 20

Background

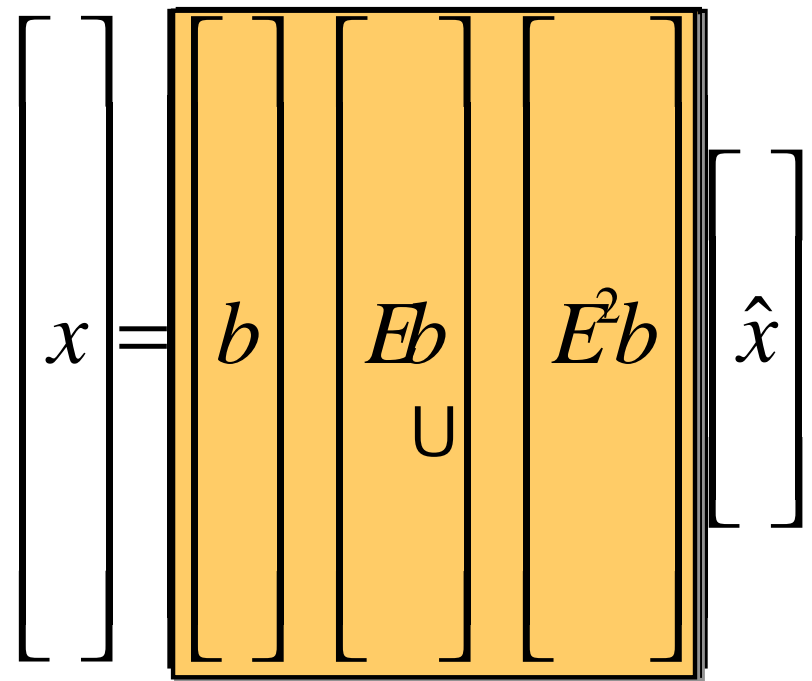
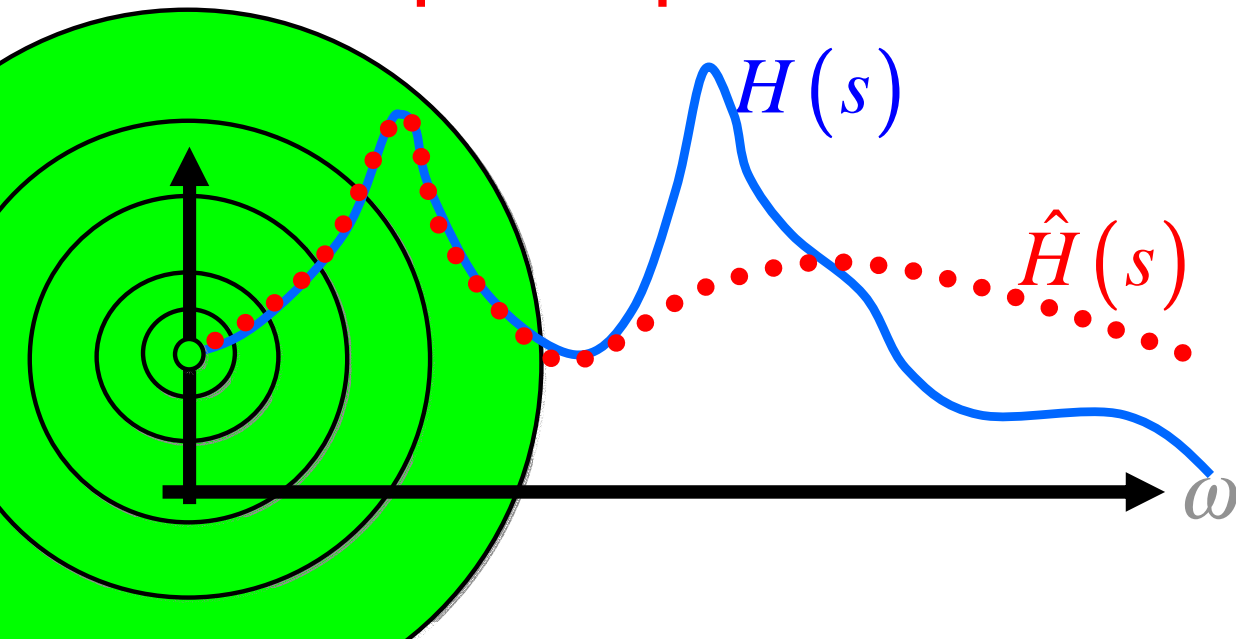
Model order reduction (cont.)

$$sEx = x + bu \quad \Rightarrow \quad x = -(I - sE)^{-1} bu$$

Taylor series expansion:

$$x = - \sum_{k=0}^{\infty} s^k E^k b \quad u \quad \Rightarrow \quad x \in \text{span} \{b, Eb, E^2b, \dots\}$$

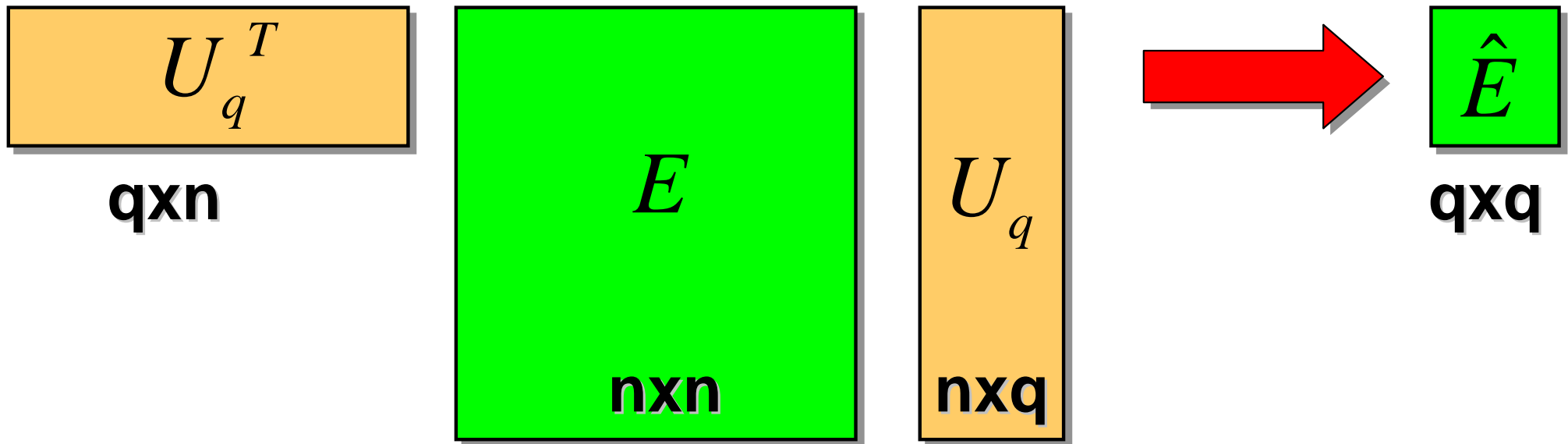
- change basis and use only the first few vectors of the Taylor series expansion: equivalent to match first derivatives around expansion point



Background Projection Framework (cont.)

$$\begin{aligned}
 sEx &= x + bu \\
 y &= c^T x
 \end{aligned}
 \quad \longrightarrow \quad
 \begin{aligned}
 &\overset{\hat{E}}{\underbrace{sU_q^T E U_q}} \hat{x} = \hat{x} + \overset{\hat{b}}{\underbrace{U_q^T b}} u \\
 y &= \underbrace{c^T U_q}_{\hat{c}^T} \hat{x}
 \end{aligned}$$

Congruence transformation



Outline

- Motivations
- Background
 - A Volume Integral Equation (VIE) formulation
 - From VIE to dynamical linear systems
 - **Linearly Parameterized Projection-based Model Reduction**
- An interpolation approach for non-linearly parameterized model order reduction
- RF-inductor Results
- Future Work and Conclusions

Background: Model Order Reduction for LINEARLY Parameterized Systems

- Given a large parameterized linear system:

$$\left(E_0 + s_1 E_1 + \dots + s_p E_p \right) x = b u$$

$y = c^T x$

$$\left(\hat{E}_0 + s_1 \hat{E}_1 + \dots + s_p \hat{E}_p \right) \hat{x} = \hat{b} u$$
$$\hat{y} = \hat{c}^T \hat{x}$$

- construct a reduced order system with similar frequency response

Background: Model Order Reduction for LINEARLY Parameterized Systems [Weile99, Daniel ISPD02]

$$\left[s_1 E_1 + \dots + s_p E_p - I \right] x = bu$$

two parameters

p-parameters

$$y = c^T x$$

$$x = - \left[I - (s_1 E_1 + \dots + s_p E_p) \right]^{-1} bu = \sum_{m=0}^{\infty} (s_1 E_1 + \dots + s_p E_p)^m b u$$

- It is a p-variables Taylor series expansion

$$x \in \text{span} \left\{ b, E_1 b, E_2 b, \dots, E_p b, E_1^2 b, (E_1 E_2 + E_2 E_1) b, \dots \right\}$$

$$\begin{bmatrix} x \end{bmatrix} = \begin{bmatrix} U_q \end{bmatrix} \begin{bmatrix} \hat{x} \end{bmatrix}$$

Once again change basis and project state onto the first few vectors of the Taylor series expansion, in order to match the first derivatives with respect to all parameters

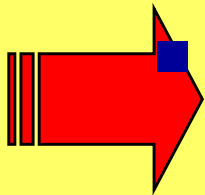
Background: Model Order Reduction for LINEARLY Parameterized Systems [Daniel et al. ISPD02]

$$\begin{array}{c}
 [E_0 + s_1 E_1 + \dots + s_p E_p] x = b u, \quad y = c^T x \\
 \downarrow \quad \downarrow \quad \downarrow \quad \downarrow \quad \downarrow \\
 \hat{E}_0 \quad \hat{E}_1 \quad \hat{E}_p \quad \hat{b} \quad \hat{c} \\
 \underbrace{U^T E_0 U}_{\hat{E}_0} + s_1 \underbrace{U^T E_1 U}_{\hat{E}_1} + \dots + s_p \underbrace{U^T E_p U}_{\hat{E}_p} x = \underbrace{U^T b}_{\hat{b}} u, \quad y = \underbrace{c^T U}_{\hat{c}} x
 \end{array}$$

$$\boxed{U^T} \quad \boxed{E_k} \quad \boxed{U} = \boxed{\hat{E}_k}$$

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An interpolation approach for non-linearly parameterized model order reduction

- RF-inductor Results

- Future Work and Conclusions

Hypothesis

■ Design parameters:

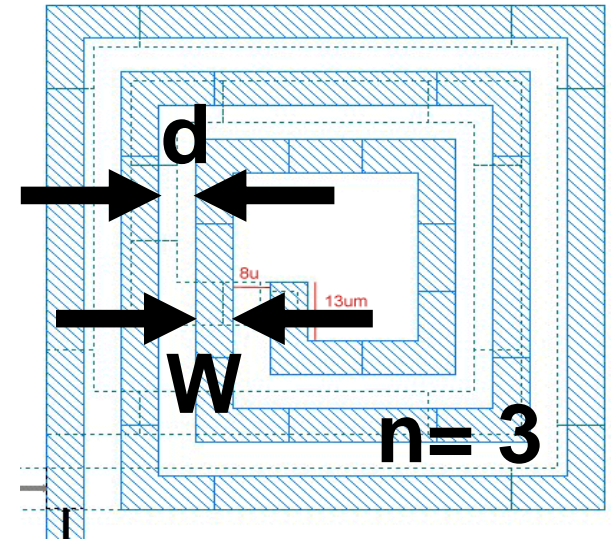
- wire dimensions and separations,
- ~~□ number of turns~~
- ~~□ type of substrate and distance from wires~~

■ Performance parameters:

- inductance
- quality factor Q
- resonance frequency
- power
- area

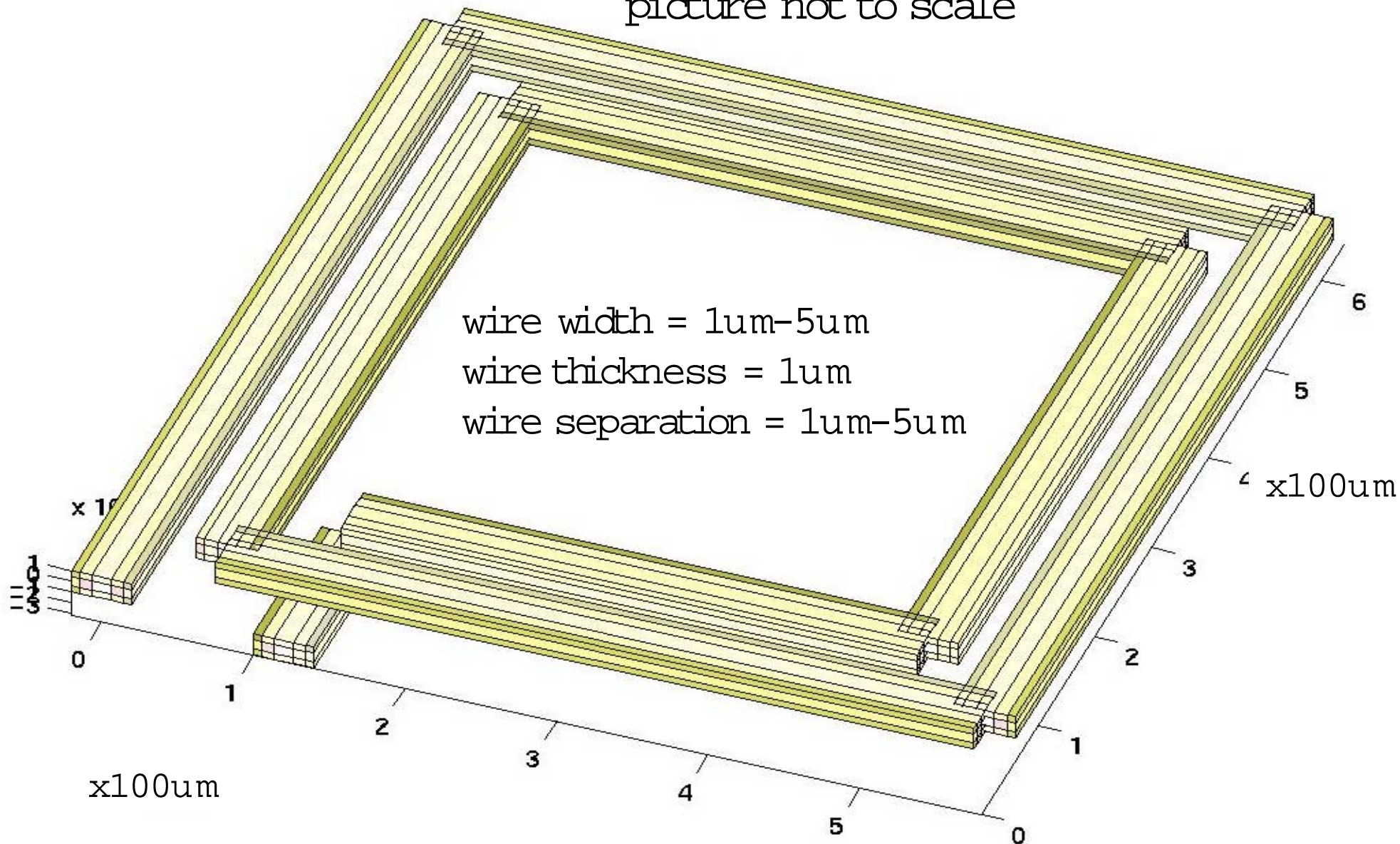
■ Effects captured:

- | | |
|--|-----------------------------------|
| □ displacement currents | affect resonance |
| □ skin effect in wires | affect Q |
| □ proximity effect in wires | affect Q |
| □ dielectrics | affect Q and resonance |
| □ substrate eddy currents | affect Q and resonance |
| □ interference with other devices | |



A simple example: Parameterized model reduction of a two-turns RF-Inductor

overall dimensions = 600 μm x600 μm
picture not to scale



An Interpolation Approach for Model Order Reduction of NON-LINEARLY Parameterized Systems



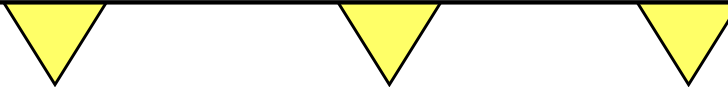
$$[R(W,d) + s L(W,d)] x = b u$$



1. Fit a low order polynomial (e.g. quadratic) to the evaluated matrices R and L

$$R(W,d) \approx R_{0,0} + W R_{1,0} + d R_{0,1} + W^2 R_{2,0} + W d R_{1,1} + d^2 R_{0,2}$$

$$L(W,d) \approx L_{0,0} + W L_{1,0} + d L_{0,1} + W^2 L_{2,0} + W d L_{1,1} + d^2 L_{0,2}$$



$$[R_{0,0} + W R_{1,0} + d R_{0,1} + W^2 R_{2,0} + W d R_{1,1} + d^2 R_{0,2} + \dots$$

$$s L_{0,0} + s W L_{1,0} + s d L_{0,1} + s W^2 L_{2,0} + s W d L_{1,1} + s d^2 L_{0,2}] x = b u$$

An **Interpolation Approach** for Model Order Reduction of **NON-LINEARLY** Parameterized Systems

- Selected a grid of 9 evaluation points for different combination of parameters

$$(W, d) = (1\mu\text{m}, 1\mu\text{m}), (1\mu\text{m}, 3\mu\text{m}), (1\mu\text{m}, 5\mu\text{m}), \\ (3\mu\text{m}, 1\mu\text{m}), (3\mu\text{m}, 3\mu\text{m}), (3\mu\text{m}, 5\mu\text{m}), \\ (5\mu\text{m}, 1\mu\text{m}), (5\mu\text{m}, 3\mu\text{m}), (5\mu\text{m}, 5\mu\text{m})$$

- Used the Volume Integral Equation code to generate system matrices $L_k = L(W_k, d_k)$ and $R_k = R(W_k, d_k)$ for each combination of parameters



$$\begin{bmatrix} M_f R_f M_f^T & M_p \\ -M_p^T & 0 \end{bmatrix} + s \begin{bmatrix} M_f L_f M_f^T & 0 \\ 0 & P^{-1} \end{bmatrix} x = bu$$

$\underbrace{\quad}_{L_k} \qquad \underbrace{\quad}_{R_k}$

Calculating Interpolation coefficients

- Need to calculate 6 polynomial coefficients
- Hence need at least 6 equations imposing fit in 6 evaluation points
- However in general it is better to use more evaluation points than the minimum.
- For instance here we used the 9 evaluation points above and solved with a least square method

$$\begin{bmatrix}
 1 & W_1 & d_1 & W_1^2 & W_1 d_1 & d_1^2 \\
 1 & W_2 & d_2 & W_2^2 & W_2 d_2 & d_2^2 \\
 1 & W_3 & d_3 & W_3^2 & W_3 d_3 & d_3^2 \\
 1 & W_4 & d_4 & W_4^2 & W_4 d_4 & d_4^2 \\
 1 & W_5 & d_5 & W_5^2 & W_5 d_5 & d_5^2 \\
 1 & W_6 & d_6 & W_6^2 & W_6 d_6 & d_6^2 \\
 1 & W_7 & d_7 & W_7^2 & W_7 d_7 & d_7^2 \\
 1 & W_8 & d_8 & W_8^2 & W_8 d_8 & d_8^2 \\
 1 & W_9 & d_9 & W_9^2 & W_9 d_9 & d_9^2
 \end{bmatrix}
 \begin{bmatrix}
 R_{0,0}^{i,j} \\
 R_{1,0}^{i,j} \\
 R_{2,0}^{i,j} \\
 R_{1,1}^{i,j} \\
 R_{0,2}^{i,j}
 \end{bmatrix}
 =
 \begin{bmatrix}
 R_1^{i,j} \\
 R_2^{i,j} \\
 R_3^{i,j} \\
 R_4^{i,j} \\
 R_5^{i,j} \\
 R_6^{i,j} \\
 R_7^{i,j} \\
 R_8^{i,j} \\
 R_9^{i,j}
 \end{bmatrix}$$

An Interpolation Approach for Model Order Reduction of NON-LINEARLY Parameterized Systems (cont.)

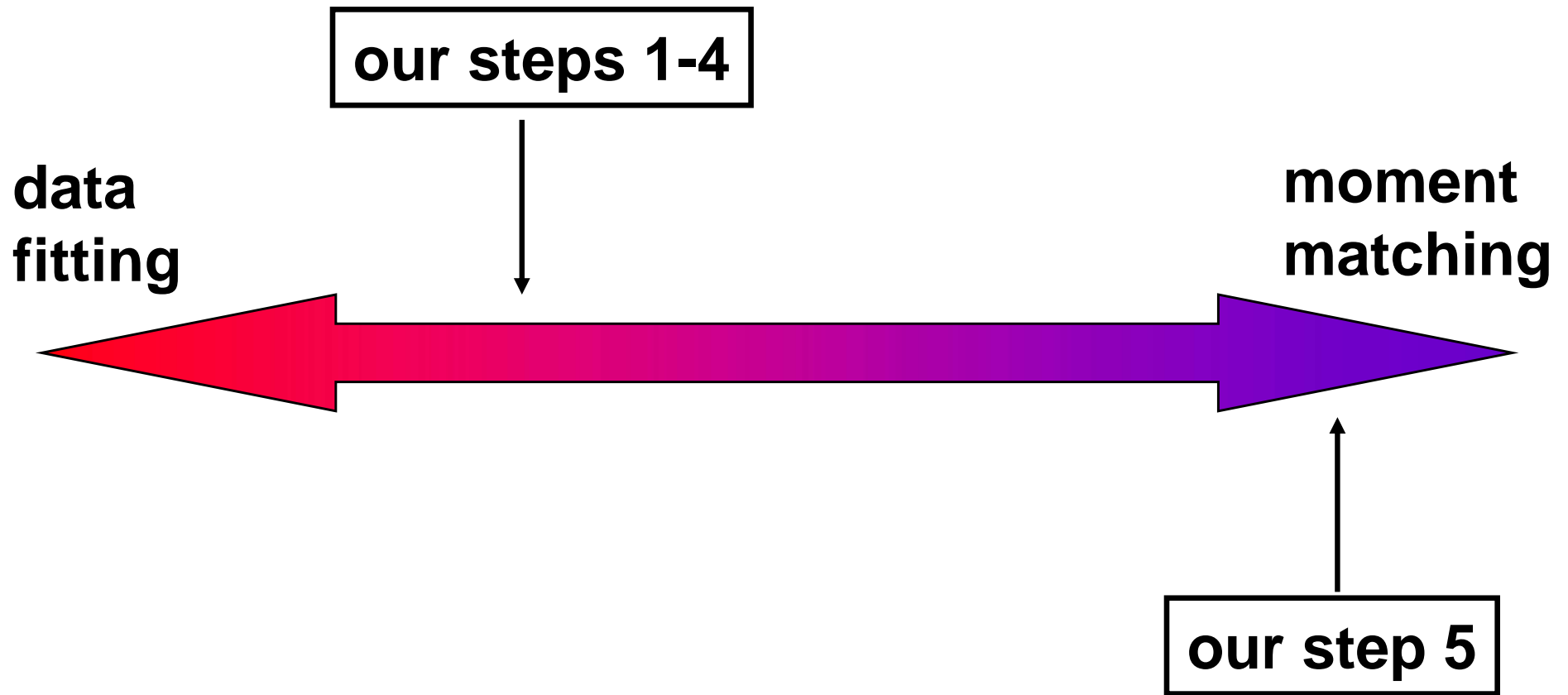
4. Transformed the polynomial parameterized system into a linearly parameterized system introducing new parameters

$$\begin{array}{cccccc}
 E_0 & s_1 E_1 & s_2 E_2 & s_3 E_3 & s_4 E_4 & s_5 E_5 \\
 \uparrow & \uparrow & \uparrow & \uparrow & \uparrow & \uparrow \\
 [R_{0,0} + WR_{1,0} + dR_{0,1} + W^2R_{2,0} + \underbrace{Wd}_{s_4} R_{1,1} + d^2 R_{0,2} + \dots \\
 sL_{0,0} + \underbrace{sW}_{s_6} L_{1,0} + \underbrace{sd}_{s_7} L_{0,1} + \underbrace{sW^2}_{s_8} L_{2,0} + \underbrace{sWd}_{s_9} L_{1,1} + \underbrace{sd^2}_{s_{10}} L_{0,2}] x = b u \\
 \downarrow & \downarrow & \downarrow & \downarrow & \downarrow & \downarrow \\
 s_6 E_6 & s_7 E_7 & s_8 E_8 & s_9 E_9 & s_{10} E_{10} & s_{11} E_{11}
 \end{array}$$

$$[E_0 + s_1 E_1 + s_2 E_2 \dots + s_{11} E_{11}] x = b u$$

5. Used the previously developed model reduction for linearly parameterized systems (ISPD02)

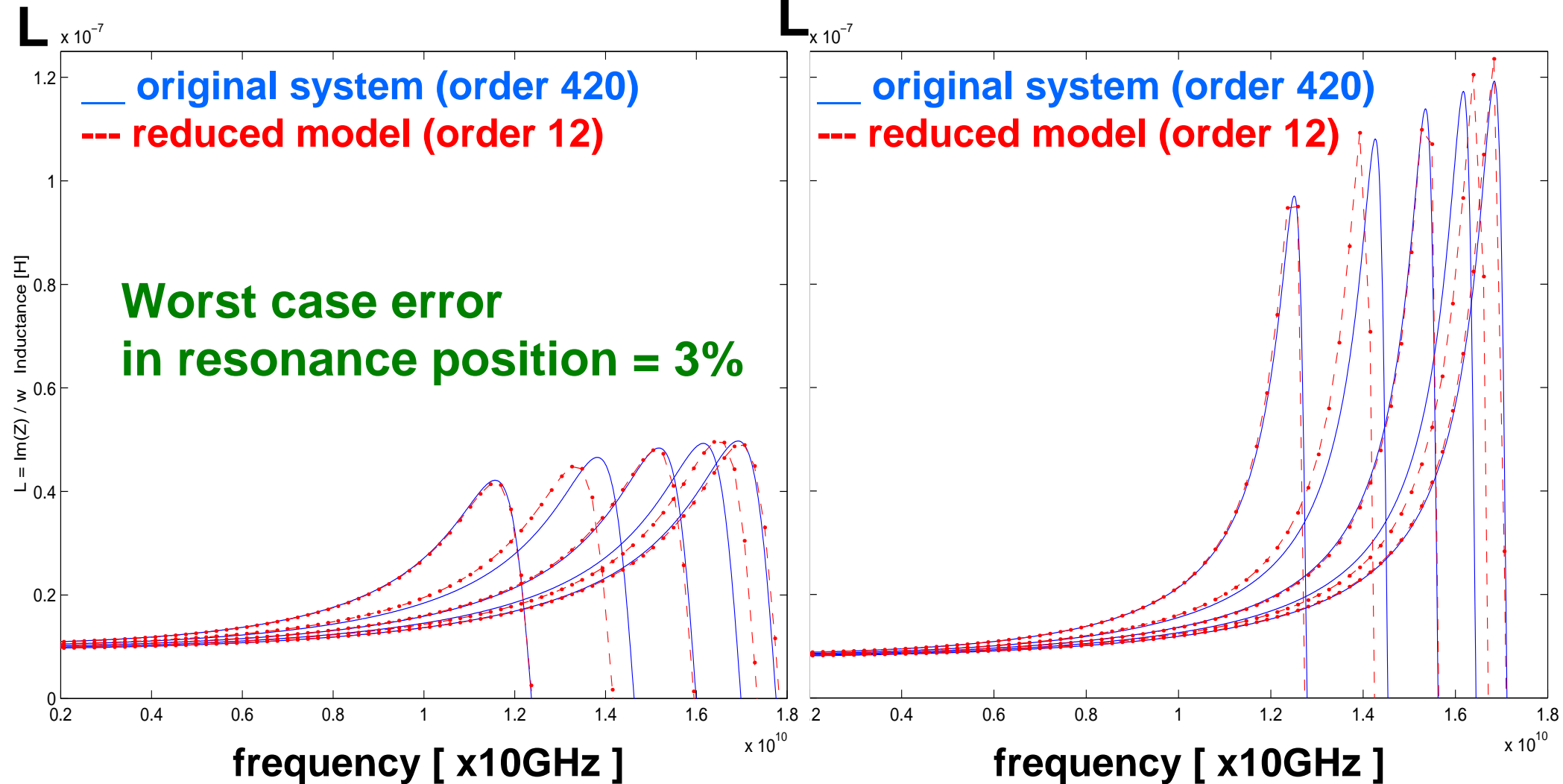
Where is this in Rutenbar's plot?



Results: Inductance vs. frequency

Wire width = 1 μ m
separation = 1 μ m, 2 μ m, 3 μ m, 4 μ m, 5 μ m

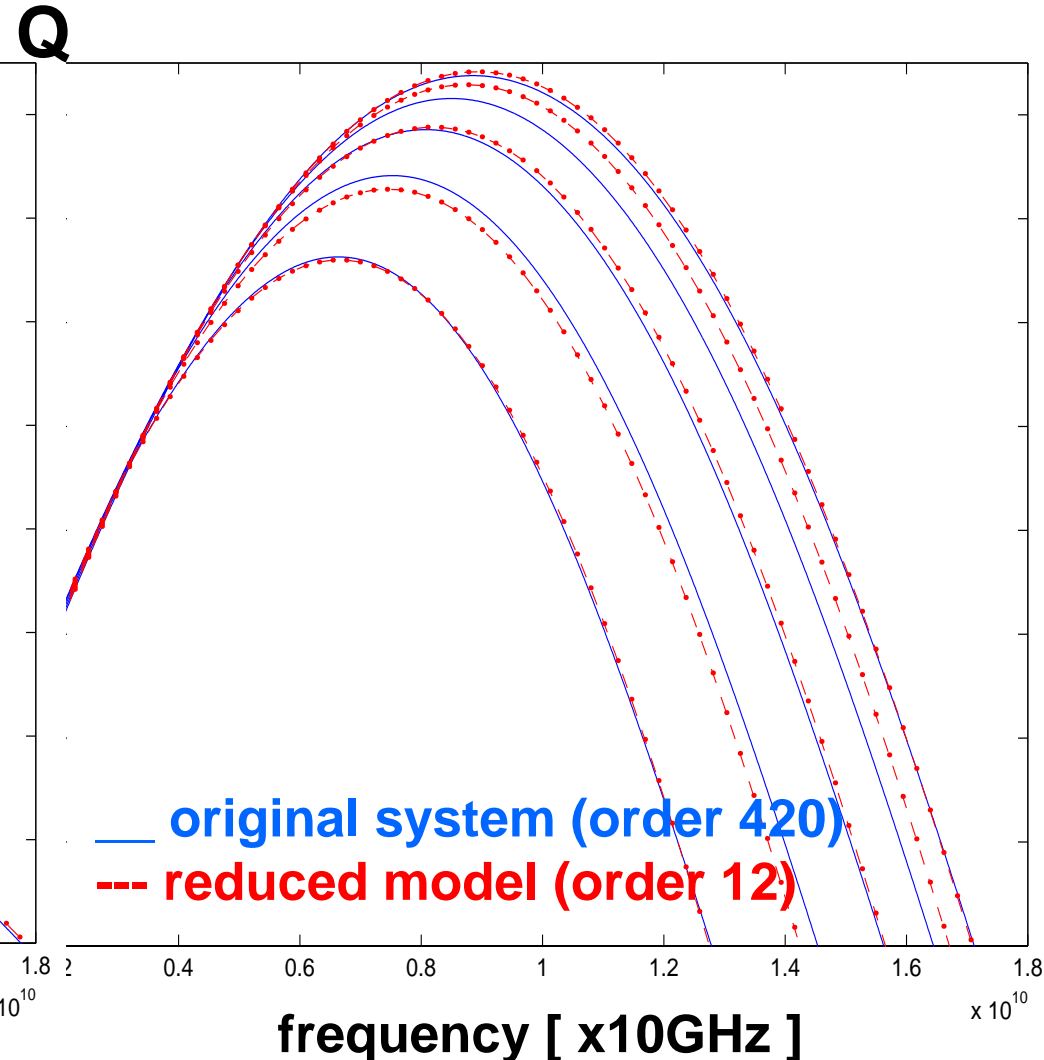
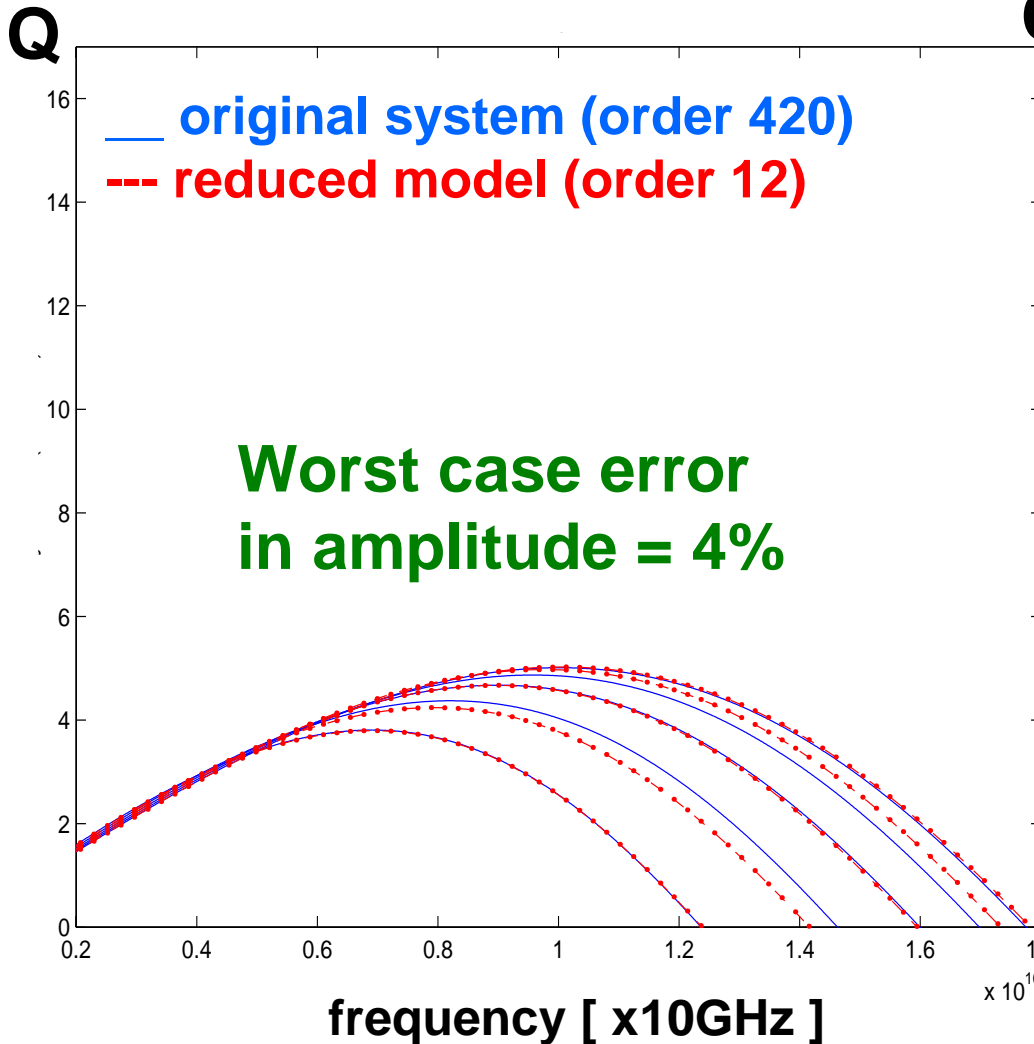
Wire width = 5 μ m
separation = 1 μ m, 2 μ m, 3 μ m, 4 μ m, 5 μ m



Results: Quality factor ($Q=wL/R$) vs. frequency

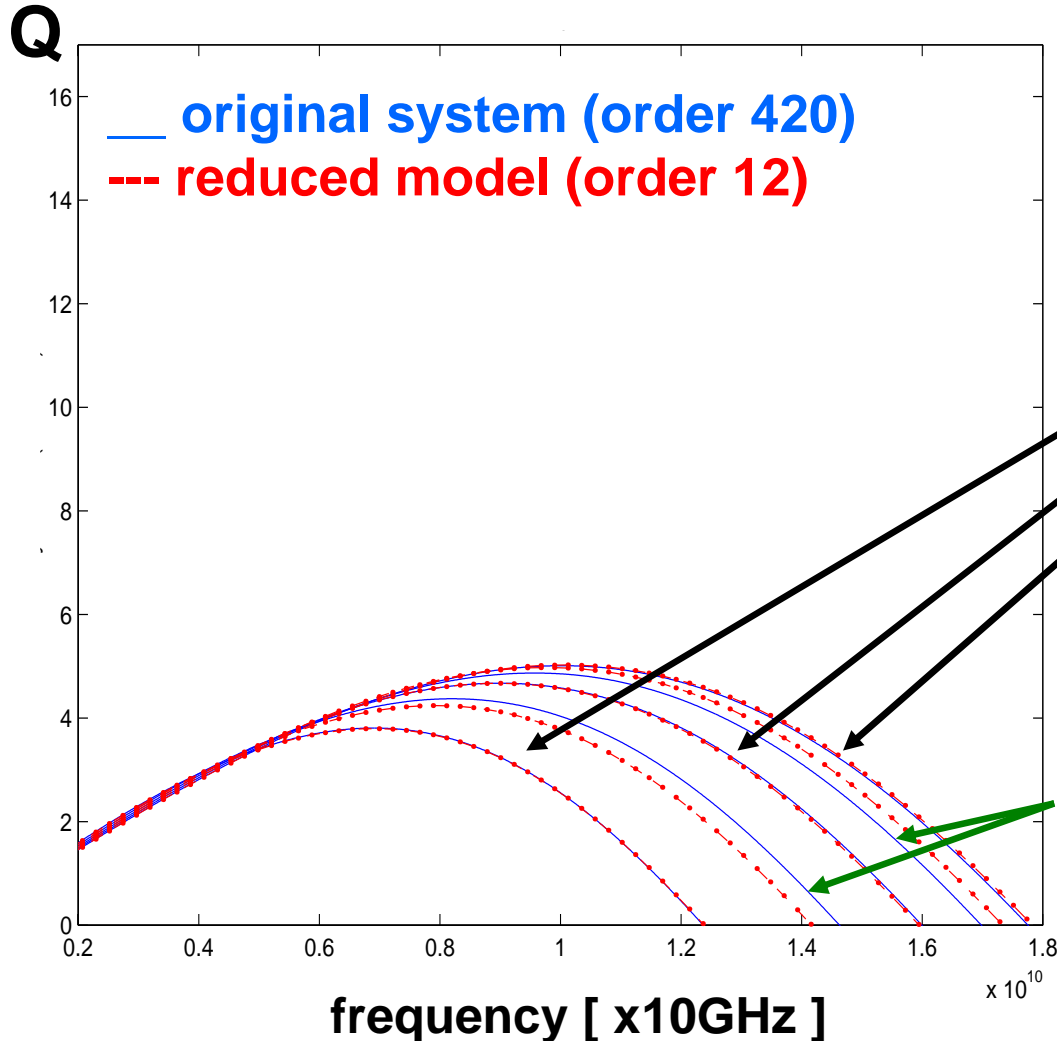
Wire width = 1 μ m
separation = 1 μ m, 2 μ m, 3 μ m, 4 μ m, 5 μ m

Wire width = 5 μ m
separation = 1 μ m, 2 μ m, 3 μ m, 4 μ m, 5 μ m



Limitations and future work use better interpolation!

Wire width = 1 μ m
separation = 1 μ m, 2 μ m, 3 μ m, 4 μ m, 5 μ m



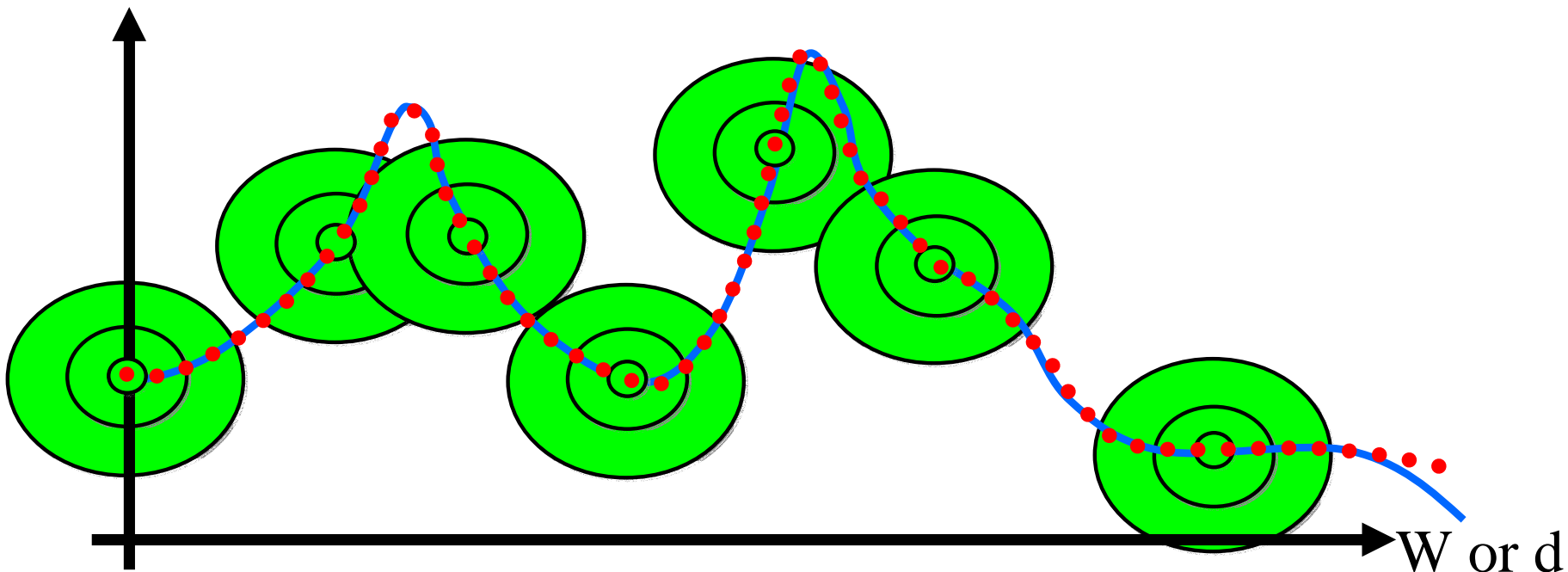
very little error in the
points used for fitting
1 μ m, 3 μ m, 5 μ m

so the critical step
is the fitting!!

Worst case errors far
from fitting points 2 μ m, 4 μ m
(3% in resonance position)

Limitations and future work in parameterized reduced order modeling

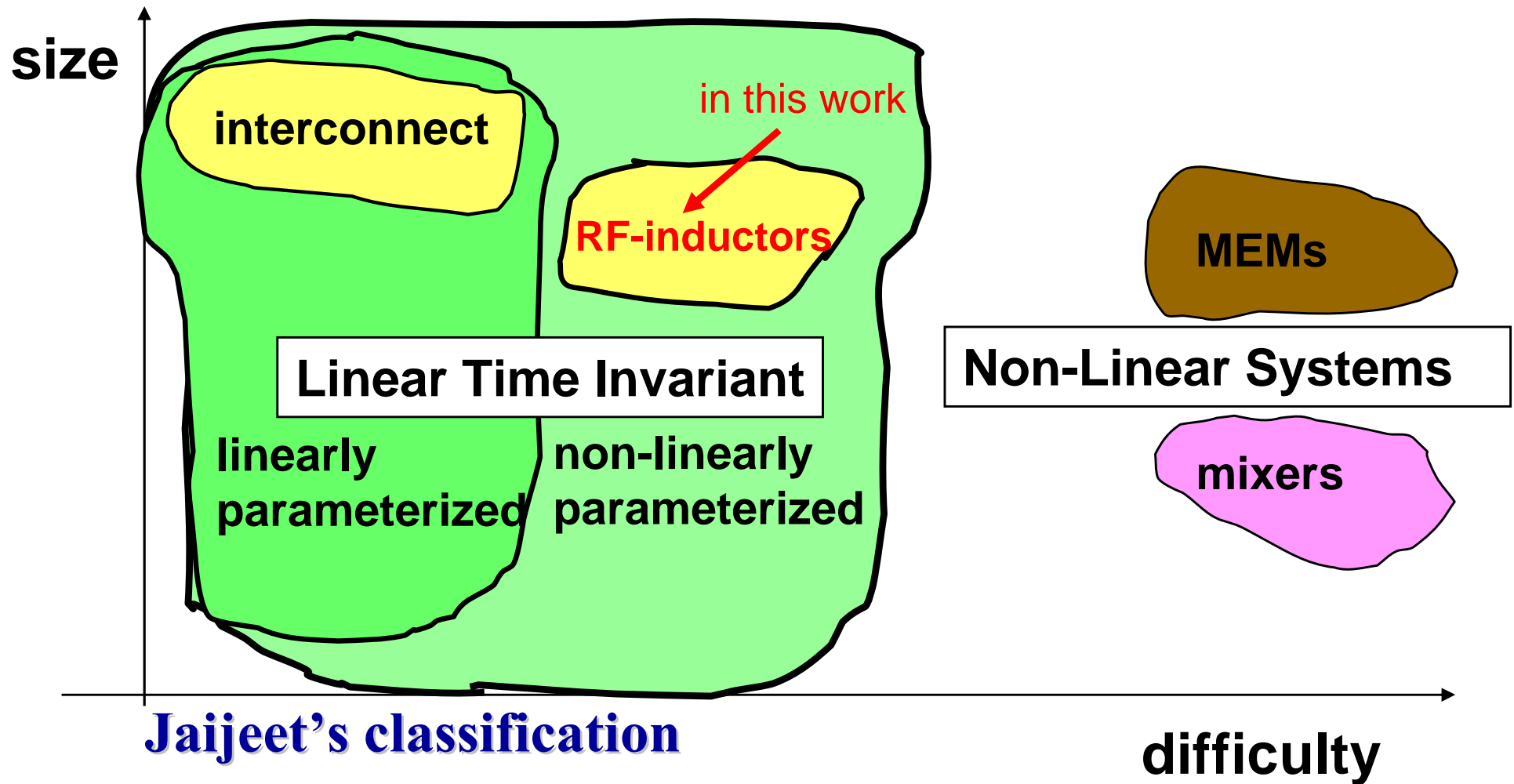
- As for linearly parameterized MOR in ISPD02, **Model order grows as $O(p^m)$** where $p = \#$ parameters and $m = \#$ derivatives matched for each parameter
 - however is linear in $\#$ of parameters when matching only one derivative ($m = 1$) per parameter s_j and still produces good accuracy in our experiments.
 - furthermore can try **multiple points** moment matching in parameterized reduction



Limitations and future work. include other second order effects

- Need to include effects of IC **substrate** and **Full-wave** effects
 - important for RF inductors, packages and other applications
 - e.g. use green functions (most computationally effective for field solver)
 - but most challenging from model reduction standpoint

Future work. Need parameterized model reduction for non-linear systems



- Need parameterized model order reduction for non-linear systems
 - much more complicated than non-linearly parameterized system response: cannot even talk about a “frequency” response

Conclusions

- **Systems on Chip and on Package are becoming a collection of very heterogeneous components**
- **Parameterized Reduced Order Modeling can enable system optimization** by producing component models:
 - automatically and robustly
 - as accurate as a field solver
 - small for evaluation within an optimization loop
- **Non-linear dependency on geometric parameters can be captured by simple polynomial interpolation**
- **Introducing new parameters for each polynomial term transforms system into a linearly parameterized reduction problem (can use e.g. Daniel ISPD02)**
- **Example: simple two turns RF-inductor neglecting substrate, parameterized models are 3-4% accurate**